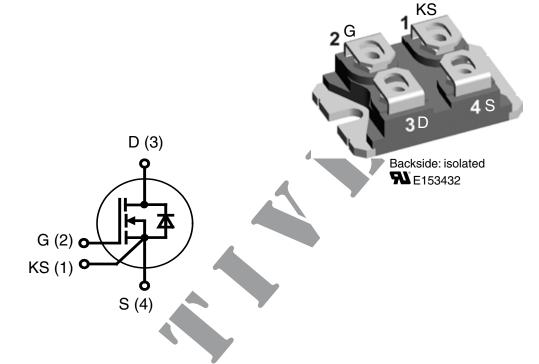


SiC Power MOSFET

I_{D25} 48 A = 1200 V V_{DSS} $\mathbf{R}_{\mathrm{DS(on)\;max}}$ = 50 m Ω

Kelvin Source gate connection

Part number IXFN50N120SK



Features / Advantages:

- High speed switching with low capacitances
- High blocking voltage with low R_{DS(on)}
- Easy to parallel and simple to drive
- Resistant to latch-up
- Real Kelvin source connection

Applications:

- Solar inverters
- High voltage DC/DC converters
- Motor drives
- Switch mode power supplies
- UPS
- Battery chargers
- Induction heating

Package: SOT-227B (minibloc)

- Isolation Voltage: 3000 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Base plate with Aluminium nitride insolation
- Advanced power cycling

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you. Should you intend to use the product in aviation, in health or live endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments:
- the conclusion of quality agreements;
 to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, test conditions and dimensions.

20160225



MOSFET				Ratings			
Symbol	Definitions	Conditions		min.	typ.	max.	
V _{DS(max)}	max drain source voltage					1200	V
V _{GS(max)}	max transient gate source voltage continous gate source voltage	recommended operational value		-10 -5		+25 +20	V V
I _{D25} I _{D80} I _{D100}	drain current	V _{GS} = 20 V	$T_{C} = 25^{\circ}C$ $T_{C} = 80^{\circ}C$ $T_{C} = 100^{\circ}C$			48 38 33	A A A
R _{DSon}	static drain source on resistance	$I_D = 40 \text{ A}; V_{GS} = 20 \text{ V}$	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 150^{\circ}C$		40 84	52	mΩ mΩ
V _{GS(th)}	gate threshold voltage	$_{\sim}$ I _D = 10 mA; V _{GS} = V _{DS}	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 150^{\circ}C$	2.4	2.8 2.0	tbd	V
I _{DSS}	drain source leakage current	V _{DS} = 1200 V; V _{GS} = 0 V	$T_{VJ} = 25^{\circ}C$		1	100	μΑ
I _{GSS}	gate source leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 20 \text{ V}$	$T_{VJ} = 25^{\circ}C$			0.25	μA
R_{G}	internal gate resistance	f = 1 MHz, V _{AC} = 25 mV			1.8		Ω
C _{iss} C _{oss} C _{rss}	input capacitance output capacitance reverse transfer (Miller) capacitance	V _{DS} = 1000 V; V _{GS} = 0 V; f = 1 MHz	$T_{VJ} = 25^{\circ}C$		1895 150 10		pF pF pF
$egin{array}{c} oldsymbol{Q}_{g} \ oldsymbol{Q}_{gs} \ oldsymbol{Q}_{gd} \end{array}$	total gate charge gate source charge gate drain (Miller) charge	$V_{DS} = 800 \text{ V}; I_D = 40 \text{ A}; V_{GS} = -5/20 \text{ V}$	' T _{VJ} = 25°C		115 28 37		nC nC nC
$egin{array}{l} t_{d(on)} \ t_r \ t_{d(off)} \ t_f \ E_{on} \ E_{off} \end{array}$	turn-on delay time current rise time turn-off delay time current fall time turn-on energy per pulse turn-off energy per pulse	Inductive switching T. Free Wheeling Diode: Body Diode $V_{DS} = 800 \text{ V}; I_D = 40 \text{A}$ $V_{GS} = -5/20 \text{ V}; R_G = 2.5 \Omega \text{ (external)}$	_{WJ} = 125°C ② V _{GS} = -5V				ns ns ns ns mJ mJ
R _{thJC}	thermal resistance junction to case thermal resistance junction to heatsink	with heatsink compound; IXYS test	setup		0.72	0.6	K/W K/W

Source-Drain Diode					Ratings		
Symbol	Definitions	Conditions		min.	typ.	max.	
I _{S25}	continuous source current	V _{GS} = -5 V	$T_{C} = 25^{\circ}C$ $T_{C} = 80^{\circ}C$				A A
V _{SD}	forward voltage drop	$I_F = 20 \text{ A}; V_{GS} = -5 \text{ V}$	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 150^{\circ}C$		3.3 3.1		V
t _{rr} Q _{RM} I _{RM}	reverse recovery time reverse recovery charge (intrinsic diod max. reverse recovery current	$V_{GS} = -5 \text{ V}; I_F = 40 \text{ A}$ $V_R = 800 \text{ V}; -di_F/dt = 1000 \text{ A/}\mu\text{s}$	T _{vJ} = 25°C		54 285 15		ns nC A

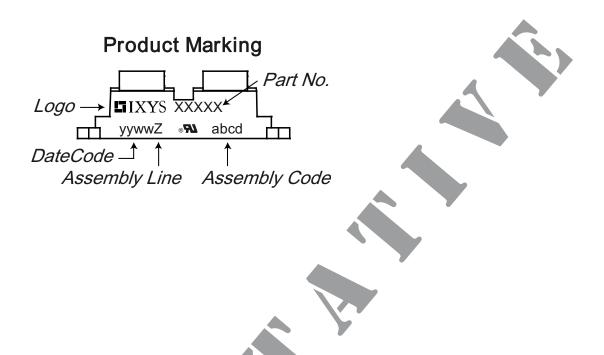
Note:

When using SiC Body Diode the maximum recommended $V_{GS} = -5V$

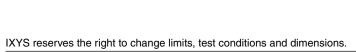




					Ratir	ngs	
Symbol	Definitions	Conditions		min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal					Д
T _{stg}	storage temperature	-		-40		150	°C
T _{op}	operation temperature			-40		150	°C
T _{VJ}	virtual junction temperature			-40		175	°C
Weight					30		g
M _D	mounting torque			1.1		1.5	Nm
M _T	terminal torque			1.1		1.5	Nm
d _{Spp/App}		aliata a a a thua cala aiu	terminal to backside	10.5 / 3.2			mm
d _{Spb/Apb}	creepage distance on surface I striking	uistance unrough air	terminal to terminal	8.6 / 6.8			mm
V _{ISOL}	isolation voltage	$I_{ISOL} \le 1 \text{ mA}; 50/60 \text{ Hz},$	t = 1 sec.	3000			V
			t = 1 minute	2500			V

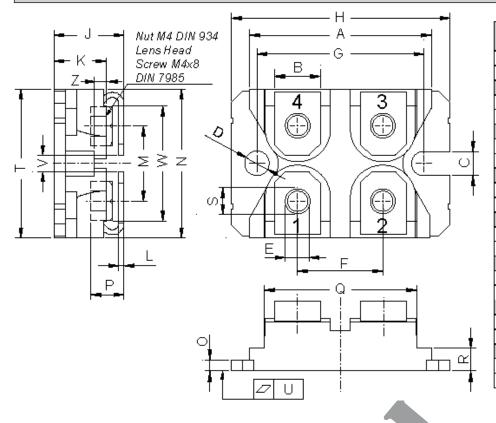


Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	IXFN50N120SK	IXFN50N120SK	Tube	10	517988

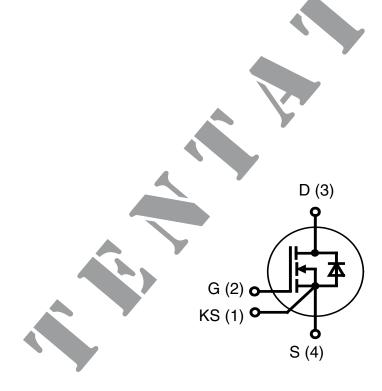




Outlines SOT-227B (minibloc)



Dim.	Millir	neter	Inches		
DIM.	min	max	min	max	
Α	31.50	31.88	1.240	1.255	
В	7.80	8.20	0.307	0.323	
С	4.09	4.29	0.161	0.169	
О	4.09	4.29	0.161	0.169	
Е	4.09	4.29	0.161	0.169	
F	14.91	15.11	0.587	0.595	
G	30.12	30.30	1.186	1.193	
Н	37.80	38.23	1.488	1.505	
۲	11.68	12.22	0.460	0.481	
Κ	8.92	9.60	0.351	0.378	
Γ	0.74	0.84	0.029	0.033	
M	12.50	13.10	0.492	0.516	
Ν	25.15	25.42	0.990	1.001	
0	1.95	2.13	0.077	0.084	
Р	4.95	6.20	0.195	0.244	
Q	26.54	26.90	1.045	1.059	
R	3.94	4.42	0.155	0.167	
S	4.55	4.85	0.179	0.191	
Т	24.59	25.25	0.968	0.994	
С	-0.05	0.10	-0.002	0.004	
٧	3.20	5.50	0.126	0.217	
W	19.81	21.08	0.780	0.830	
Ζ	2.50	2.70	0.098	0.106	



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Discrete Semiconductor Modules category:

Click to view products by IXYS manufacturer:

Other Similar products are found below:

<u>M252511FV</u> <u>DD2</u>	60N12K-A	DD380N16A	DD89N1600K-	\underline{A} $\underline{APT2X21D0}$	C60J <u>APT58M</u>	80J B522F-2-Y	YEC MSTC90-1	<u>16</u> <u>25.163.0653.1</u>
25.163.2453.0 25.3	163.4253.0	25.190.2053.0	25.194.3453.0	25.320.4853.1	25.320.5253.1	25.326.3253.1	25.326.3553.1	25.330.1653.1
25.330.4753.1 25.3	330.5253.1	25.334.3253.1	25.334.3353.1	25.350.2053.0	25.352.4753.1	25.522.3253.0	<u>T483C</u> <u>T484C</u>	<u>T485F</u> <u>T485H</u>
T512F-YEB T513	F T514F T	554 <u>T612FSE</u>	25.161.3453.0	25.179.2253.0	25.194.3253.0	25.325.1253.1	25.326.4253.1	25.330.0953.1
25.332.4353.1 25.3	350.1653.0	25.350.2453.0	25.352.1453.0	25.352.1653.0	25.352.2453.0	25.352.5453.1	25.522.3353.0	25.602.4053.0
25.640.5053.0								